

EAST Search notes

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	20	(anodic) near4 (bonding or joining or bond or bonded or joined or fusing or fused) near8 (glass or bpsg or psg or silica or pyrex) near8 ((metal or metallic) near2 (stack or stacked or laminate or layers or layered))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 09:44
L2	6	"5395481".pn. "5538151".pn. "6638627".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 09:31
L3	131	(anodic) near4 (bonding or joining or bond or bonded or joined or fusing or fused) near8 (glass or bpsg or psg or silica or pyrex) near3 (metal or metallic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 10:10
L4	36	((tin or sn) near4 (gold or au)) near5 ((reactivity or reaction or activity) near4 (oxygen or oxide or ol) or oxidizability or oxidized or oxidizing)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 09:47
L5	1086	438/455.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 10:39
L6	282	438/455.ccls. and (electrostatic or anodic or electro-static or (bonding or bonded or bond or adhered or adhesive or attached or affixed or attaching or attachment or affixing or secured or laminated or lamination or glued or gluing) near4 (bias or biasing or voltage or biased or power or field))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 11:00
L7	246	438/456.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 10:55
L8	66	438/470.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 11:00
L9	1283	156/272.2.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 11:00
L10	169	156/272.2.ccls. and (electrostatic or anodic or electro-static or (bonding or bonded or bond or adhered or adhesive or attached or affixed or attaching or attachment or affixing or secured or laminated or lamination or glued or gluing) near4 (bias or biasing or voltage or biased or power or field))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 11:02
S1	908	(anodic) near4 (bonding or joining or bond or bonded or joined or fusing or fused) near8 (conductor or semiconductor or silicon or si) near6 (glass or bpsg or psg or silica)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 09:30
S2	5	(anodic) near4 (bonding or joining or bond or bonded or joined or fusing or fused) near8 (conductor or semiconductor or silicon or si) near6 (glass or bpsg or psg or silica) near15 (gold or au or silver or ag or copper or cu or nickel or ni or platinum or pt or palladium or pd or lead or pb or tin or sn) near15 (aluminum or al or chromium or cr or titanium or ti or vanadium or v or tungsten or w)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/25 10:33

S3	135	(anodic) near4 (bonding or joining or bond or bonded or joined or fusing or fused) same (conductor or semiconductor or silicon or si) same (glass or bpsg or psq or silica) same (gold or au or silver or ag or copper or cu or nickel or ni or platinum or pt or palladium or pd or lead or pb or tin or sn) same (aluminum or al or chromium or cr or titanium or ti or vanadium or v or tungsten or w)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/25 11:07
S4	63	(anodic) near4 (bonding or joining or bond or bonded or joined or fusing or fused or binding) same (glass or bpsg or psq or silica or quartz or plastic) near6 (gold or au or silver or ag or copper or cu or nickel or ni or platinum or pt or palladium or pd or lead or pb or tin or sn or aluminum or al or chromium or cr or titanium or ti or vanadium or v or tungsten or w) near4 (between or interface or interfacing or joining or intermediate or interposing or separating or sandwich\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 09:00
S5	45	(bonding or joining or bond or bonded or joined or fusing or fused or binding) near8 (glass or bpsg or psq or silica or quartz or plastic) near6 (gold or au or silver or ag or copper or cu or nickel or ni or platinum or pt or palladium or pd or lead or pb or tin or sn or aluminum or al or chromium or cr or titanium or ti or vanadium or v or tungsten or w) near4 (between or interface or interfacing or joining or intermediate or interposing or separating or sandwich\$3) same (bias or biasing or voltage or biased)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 09:19
S6	26	("3397278" "3470348" "4141136" "4452624" "4701424" "4810671" "4927505" "5227250" "5286671" "5294241" "5346857" "5368880" "5682065" "5695590" "5709724" "5837562" "5989372" "6096414" "6131410" "6231925" "6274252" "6346305" "6417478" "6475326").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/26 09:11
S7	10	("3397278" "4083710" "4389277" "4393105" "4643532" "5431806" "5663078" "5820648" "6113218").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/26 09:16
S8	1	("6417478").URPN.	USPAT	OR	ON	2006/01/26 09:18
S9	95	(bonding or joining or bond or bonded or joined or fusing or fused or binding) near6 (electrostatic or electro-static or anodic or voltage or bias or biasing or biased) near8 (glass or bpsg or psq or silica or quartz or plastic) same (gold or au or silver or ag or copper or cu or nickel or ni or platinum or pt or palladium or pd or lead or pb or tin or sn or aluminum or al or chromium or cr or titanium or ti or vanadium or v or tungsten or w) near4 (between or interface or interfacing or joining or intermediate or interposing or separating or sandwich\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 10:30
S10	113	(bonding or joining or bond or bonded or joined or fusing or fused or binding) near3 (electrostatic or electro-static or anodic or voltage or bias or biasing or biased) near10 (glass or bpsg or psq or silica or quartz or plastic) near10 (wafer or substrate or silicon or si or semiconductor) near10 (gold or au or silver or ag or copper or cu or nickel or ni or platinum or pt or palladium or pd or lead or pb or tin or sn or aluminum or al or chromium or cr or titanium or ti or vanadium or tungsten or w)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 11:18
S11	2	(bonding or joining or bond or bonded or joined or fusing or fused or binding) near3 (electrostatic or electro-static or anodic or voltage or bias or biasing or biased) near10 (glass or bpsg or psq or silica or quartz or plastic) near20 (gold or au or silver or ag or copper or cu or nickel or ni or platinum or pt or palladium or pd or lead or pb or tin or sn or aluminum or al or chromium or cr or titanium or ti or vanadium or tungsten or w) near4 (interlayer or inter-layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 11:20
S12	29	(bonding or joining or bond or bonded or joined or fusing or fused or binding) near3 (electrostatic or electro-static or anodic or voltage or bias or biasing or biased) near10 (glass or bpsg or psq or silica or quartz or plastic) and (glass or bpsg or psq or silica or quartz or plastic) near4 (roughened or roughness or abraded or roughening)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 11:21

S13	14	(US-20020036667-\$ or US-20030175530-\$ or US-20040259325-\$ or US-20050077633-\$ or US-20050089924-\$).did. or (US-4639631-\$ or US-4712082-\$ or US-4772523-\$ or US-5008774-\$ or US-5313832-\$ or US-6258263-\$ or US-6417478-\$ or US-6467354-\$ or US-6939778-\$).did.	US-PGPUB; USPAT	OR	ON	2006/01/26 12:31
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Inspec - 1969 to date (INZZ)

[limit](#)

Search history:

No.	Database	Search term	Info added since	Results	
1	INZZ	(anodic OR electrostatic) NEAR (bonding OR joining OR bonded OR bond OR adhering OR affixing OR securing) NEAR (glass OR pyrex OR bpsg OR psg) NEAR (metal OR metallic OR gold OR au OR aluminum OR al OR chromium OR cr)	unrestricted	19	show titles
3	INZZ	(anodic OR electrostatic) NEAR bonding AND (gold OR au OR tin OR sn) NEAR (chromium OR cr OR titanium OR ti OR aluminum OR al) NEAR (between OR sandwich OR sandwiched OR interlayer OR interface)	unrestricted	0	-
4	INZZ	(anodic OR electrostatic) NEAR bonding AND (metal OR metallic) NEAR (between OR sandwich OR sandwiched OR interlayer OR interface)	unrestricted	6	show titles
5	INZZ	(anodic OR electrostatic) NEAR bonding AND (gold-titanium OR gold-chromium OR aucr OR crau OR tiau OR auti OR au NEAR ti OR au NEAR cr)	unrestricted	7	show titles
6	INZZ	((anodic OR electrostatic) NEAR (bonding OR bond OR joining OR fusing)).TI.	unrestricted	210	show titles
7	INZZ	((anodic OR electrostatic) NEAR (bonding OR bond OR joining OR fusing)).TI. AND (metal OR metallic OR gold OR au OR titanium OR ti OR aluminum OR al OR chromium OR cr) NEAR (interface OR interfacial OR between OR sandwich OR sandwiched OR interlayer)	unrestricted	7	show titles

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